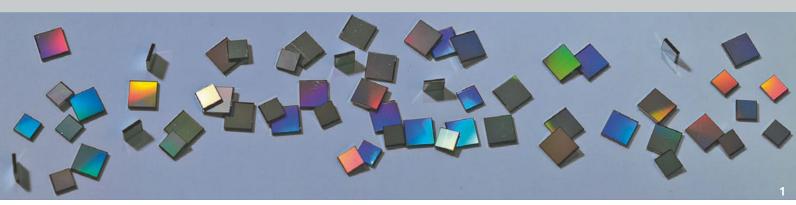


# FRAUNHOFER INSTITUTE FOR INTEGRATED SYSTEMS AND DEVICE TECHNOLOGY IISB



1 Diced high-voltage RCsnubber chips with capacitance values of 15 nF and 33 nF for automotive applications (200 V version)

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# MONOLITHIC RC-SNUBBERS AND CAPACITORS UP TO 600 V

## **General Description**

A deep trench in silicon filled with  $SiO_2$  or  $Si_3N_4$  as dielectric and doped poly-silicon as electrode forms the capacitor. The bulk silicon can be used to form the series resistor of a passive RC-snubber. The bottom side contact consists of a solder- and sinterable metal stack. The top side contact consists of bondable aluminum, or is solder- and sinterable on request. High voltage versions feature a polyimide passivation.

# Features

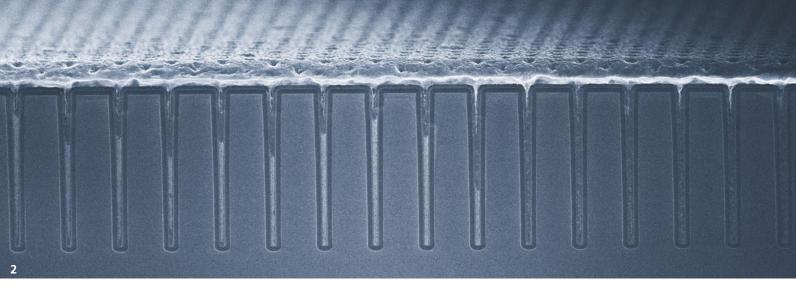
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- Low parasitic inductance (pH) compared to discrete solutions (nH)
- Available as bare-die
- High thermal conduction of Si substrate with low transition resistances
- Detailed understanding of failure mechanism and exact life-time prediction: Elimination of early failing devices
- Outstanding reproducibility and homogeneity of the fabrication process

# Advantages

- Higher switching speeds and increased efficiency of the system, e.g. energy converter
- Simplified mounting together with power switches or ICs
- More efficient spread of the thermal power dissipation to the heat sink
- Increased mean-time-to-failure resulting in lower failure rate in the field
- Excellent device tolerances, minor deviations
- Custom designs regarding capacitance, resistance and voltage stability available

#### Benefits

- Increasing sales volume due to an innovative product with increased system efficiency and SOA
- Less labor time, higher profit due to faster mounting process and less rework
- Secure and reliable systems with reduced downtime in the field



#### **Device Dimensions**

# 

1.0 mm - 4.5 mm\*

\*others on request

Bond area

# Voltage Characteristics

Fig.1 shows a typical CV-curve of an exemplary 10 nF / 1  $\Omega$  snubber capacitor with a nominal voltage of 200 V.

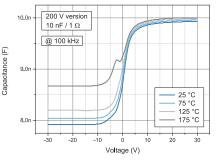


Fig. 1 Typical CV-curve (200 V / 10 nF / 1  $\Omega$ )

Fig. 2 shows a typical IV-curve of a  $600 \text{ V} / 1.5 \text{ nF} / 5 \Omega$  snubber capacitor.

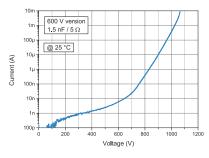


Fig. 2 Typical IV-curve (600 V / 1.5 nF / 5Ω)

# **Temperature Characteristics**

Fig. 3 shows a typical capacitance and ESR change versus the temperature curve, respectively. The trench capacitor exhibits an excellent temperature behaviour. The capacitance change is less than 1% of the nominal capacitance at room temperature with a temperature change of 100 K.The ESR change is less than 60 % of the nominal ESR at room temperature.

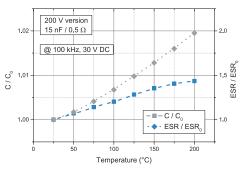


Fig. 3 Typical capacitance and ESR change vs. temperature (200 V / 10 nF / 1 Ω)

#### Frequency Characteristics

Fig. 4 shows a typical impedance curve of the integrated RC-snubber. Due to the very low ESL, the resonant frequency of the RC-snubber is very high (> 100 MHz).

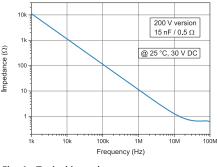


Fig. 4 Typical impedance curve (200 V / 15 nF / 0.5 Ω)

2 Cross-section of monolithically integrated high-voltage RC-snubber taken by scanning electron microscopy

# **Performance Characteristics**

Υ

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Climatic category	40/200/56
Capacitance range	1 nF – 50 nF*
Resistance range	0.2 Ω – 20 Ω*
Tolerance on $C_0$	± 3%, ± 5%
Tolerance on $R_0$	± 15%
Nominal voltage $V_0$	up to 600 V
Test voltage	1.4 V $_{\rm o}$ for 2 sec @ 25 °C
Insulation resis-	2 GΩ @ 600 V DC
tance (minimum)	
Temperature range	-40 °C – 200 °C
Δ C(T)	< 1% @ ∆ T = 100 K
Δ R(T)	60% @∆T = 100 K

\*others on request